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April 2012



Features

- High Voltage Switch Mode Application
- Fast Speed Switching
- Wide Safe Operating Area
- Suitable for Electronic Ballast Application
- Wave Soldering



1. Base 2. Collector 3. Emitter

Absolute Maximum Ratings^{*} $T_{C} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Value	Units
V _{CBO}	Collector-Base Voltage	700	V
V _{CEO}	Collector-Emitter Voltage	400	V
V _{EBO}	Emitter-Base Voltage	9	V
۱ _C	Collector Current (DC)	4	A
I _{CP}	Collector Current (Pulse)	8	A
I _B	Base Current	2	A
P _C	Collector Dissipation, $T_a = 25^{\circ}C$ $T_c = 25^{\circ}C$	1.1 50	W
ТJ	Junction Temperature	150	°C
T _{STG}	Storage Temperature	-65 to 150	°C

* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics $T_a = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Value	Units
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient	110	°C/W
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case	2.0	°C/W

* Device mounted on minimum pad size

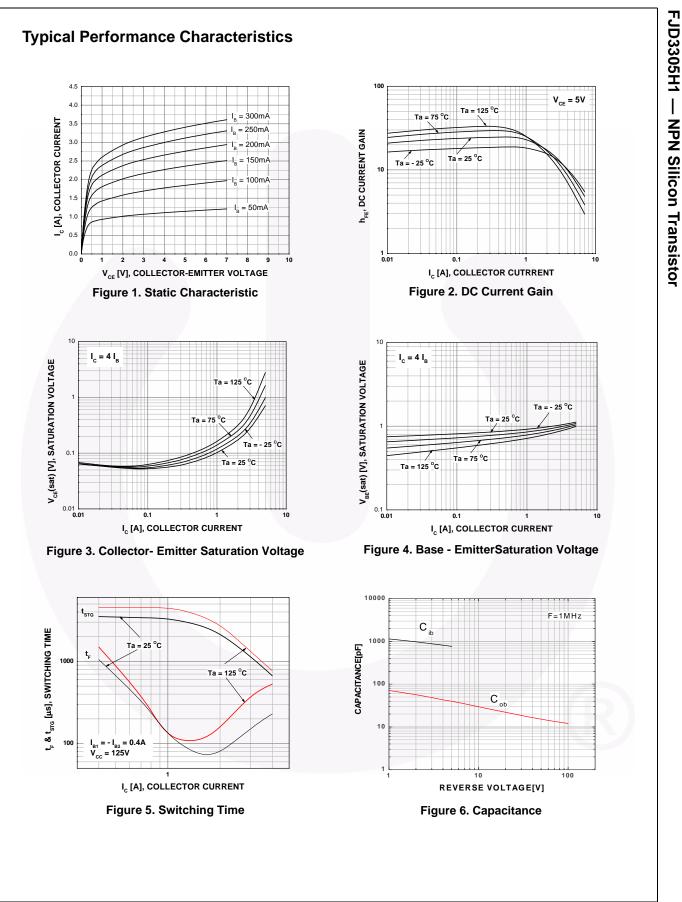
Ordering Information

Part Number	Marking	Package	Packing Method	Remarks
FJD3305H1TM	J3305H1	D-PAK	Tape & Reel	

FJD3305H1 — NPN Silicon Transistor

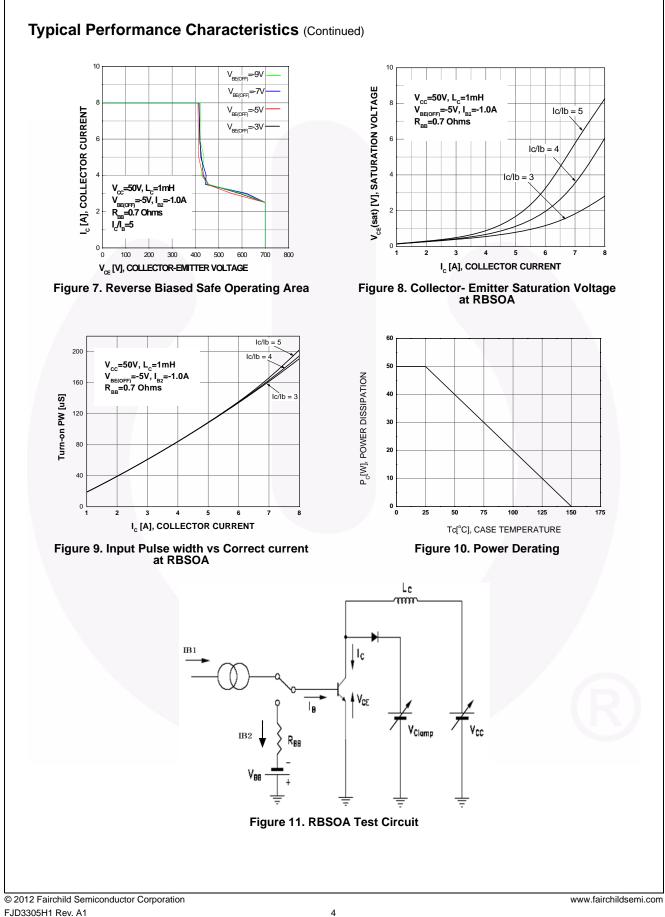
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
BV _{CBO}	Collector-Base Breakdwon Voltage	$I_{C} = 500 \mu A, I_{E} = 0$	700			V
BV _{CEO}	Collector-Emitter Breakdown Voltage	I _C = 5mA, I _B = 0	400			V
BV_{EBO}	Emitter-Base Breakdown Voltage	$I_{E} = 500 \mu A, I_{C} = 0$	9			V
I _{CBO}	Collector Cut-off Current	V _{CB} = 700V, I _E = 0			1	μA
I _{EBO}	Emitter Cut-off Current	$V_{EB} = 9V, I_{C} = 0$			1	μA
h _{FE1}	DC Current Gain *	$V_{CE} = 5V, I_{C} = 1A$	19		28	
h _{FE2}		$V_{CE} = 5V, I_{C} = 2A$	8		40	
V _{CE(sat)}	Collector-Emitter Saturation Voltage	I _C = 1A, I _B = 0.2A			0.5	V
- ()		$I_{\rm C} = 2$ A, $I_{\rm B} = 0.5$ A			0.6	V
		$I_{\rm C} = 4$ A, $I_{\rm B} = 1$ A			1.0	V
V _{BE(sat)}	Base-Emitter Saturation Voltage	I _C = 1A, I _B = 0.2A			1.2	V
		I _C = 2A, I _B = 0.5A			1.6	V
f _T	Current Gain Bandwidth Product	$V_{CE} = 10V, I_{C} = 0.5A$	4			MHz
C _{ob}	Output Capacitance	V _{CB} = 10V, f = 1MHz		65		pF
t _{ON}	Turn On Time	$V_{CC} = 125V, I_{C} = 2A$			0.8	μs
t _{STG}	Storage Time	$I_{B1} = -I_{B2} = 0.4A$			4.0	μs
t _F	Fall Time	$R_L = 62.5\Omega$			0.9	μS

* Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%



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FJD3305H1 — NPN Silicon Transistor





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